

Soldering tip bevelled 45° micro fine 0.7 mm series P (PM75BV007) - Thermaltronics PM75BV007

Item no. **WL38089**

Manufacturer **Thermaltronics**

Series P soldering tip, bevelled 45° micro fine geometry, tip width 0.7 mm (0.028 in), for the TMT-2000PS and Oki MFR-PS power units. Lead-free and RoHS compliant, fits the SHP-P and SHP-PM handpieces.

TECHNICAL DATA

Ausführungsklasse	ESD (antistatic)
Country of Manufacture	United States
HS-Code	85159080900
Weight	0.1 kg



DESCRIPTION

This series P soldering tip (PM75BV007) with a bevelled 45° micro fine geometry and a tip width of 0.7 mm (0.028 in) delivers the precision needed for fine solder joints and a stable heat transfer across the 350 to 398 °C range.

BENEFITS

- Bevelled 45° micro fine tip geometry for focused work on the joint
- Tip width 0.7 mm (0.028 in) for defined heat delivery
- Series P working temperature 350 to 398 °C
- Lead-free and RoHS compliant

TECHNICAL DATA

Item no.	WL38089
Model	PM75BV007
Manufacturer	Thermaltronics
Manufacturer item no.	PM75BV007
Product series	P, 350 °C - 398 °C
Temperature range	350-398 °C
Tip geometry	bevelled 45° micro fine

Tip width	0.7 mm (0.028 in)
Tip length	16 mm (0.63 in)
Suitable handpiece	SHP-P, SHP-PM

APPLICATIONS

Forming and reworking solder joints on PCBs with the Thermaltronics TMT-2000PS soldering systems and the Oki MFR-PS power units.

COMPATIBILITY AND SCOPE OF DELIVERY

Suitable for: TMT-2000PS, MFR-PS1100, MFR-PS2200, MFR-PS1K, MFR-PS2K. Fits the SHP-P and SHP-PM handpieces. Supplied as one piece.

Lead-free, RoHS compliant. Manufactured by Thermaltronics, USA.